



DGD2117/2118

SINGLE CHANNEL GATE DRIVER

Description

The DGD2117 and DGD2118 are high voltage / high speed gate drivers capable of driving one N-Channel MOSFET or IGBT in a bootstrap configuration. High voltage processing techniques enable the DGD2117 and DGD2118 to switch at 600V.

The DGD2117 and DGD2118 logic inputs are compatible with standard CMOS outputs. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction. The single floating channel can be used in high side and low side configuration.

The DGD2117 and DGD2118 are offered in SO-8 package and the operating temperature extends from -40° C to $+125^{\circ}$ C.

Applications

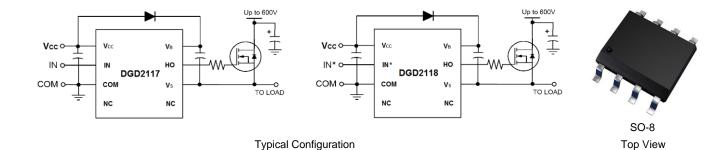
- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

Features

- Floating Channel in Bootstrap Operation to 600V
- Drives One N-Channel MOSFET or IGBT
- Outputs Tolerant to Negative Transients
- Wide Logic Supply: 10V to 20V
- Schmitt Triggered Logic Input with Internal Pull Down
- Undervoltage Lockout
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Case: SO-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (c)
- Weight: 0.075 grams (Approximate)



Ordering Information (Note 4)

Pa	art Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel	
DGI	D2117S8-13	DGD2117	13	12	2,500	
DGI	D2118S8-13	DGD2118	13	12	2,500	
DGD2118S8-13 DGD2118 13 12 2,500 Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2,500						

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and

Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

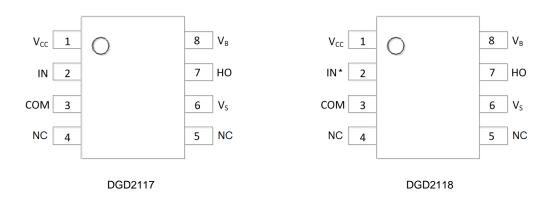
Marking Information



)'' = Manufacturer's Marking
DGD211x = Product Type Marking Code (See Table Above)
YY = Year (ex: 19 = 2019)
WW = Week (01 to 53)



Pin Diagrams

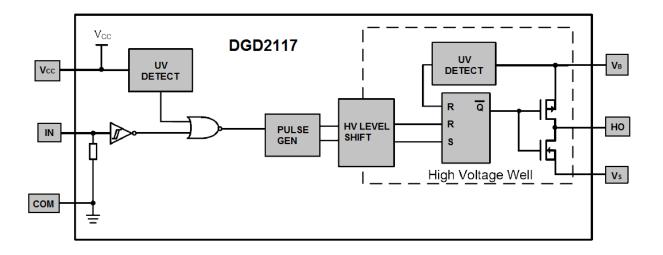


Top View SO-8

Pin Descriptions

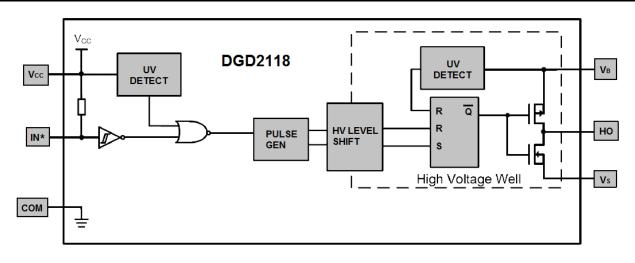
Pin Number	Pin Name	Function	
1	Vcc	Logic and gate driver supply	
2	IN	DGD2117 Logic input for gate driver output (HO), in phase with HO	
2	IN*	DGD2118 Logic input for gate driver output (HO), out of phase with HO	
3	COM	Logic ground	
4, 5	NC	No Connection (No Internal Connection)	
6	6 V _S High-side floating supply return		
7	HO	High-side gate drive output	
8	VB	High-side floating supply	

Functional Block Diagram





Functional Block Diagram (continued)



Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V
High-Side Floating Output Voltage	V _{HO}	Vs-0.3 to V _B +0.3	V
Logic Supply Voltage	Vcc	-0.3 to +24	V
Logic Input Voltage	Vin	-0.3 to Vcc+0.3	V
Allowable Offset Supply Voltage Transient	dVs / dt	50	V/ns

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W	
Thermal Resistance, Junction to Ambient (Note 5)	Reja	200	°C/W	
Thermal Resistance, Junction to Case (Note 6)	Rejc	45	°C/W	
Operating Temperature	TJ	+150		
Lead Temperature (Soldering, 10s)	TL	+300	°C	
Storage Temperature Range	Tstg	-55 to +150		

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	VB	Vs + 10	V _S + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High Side Floating Output Voltage	Vно	Vs	VB	V
Low Side and Logic Fixed Supply Voltage	V _{CC}	10	20	V
Logic Input Voltage	Vin	0	Vcc	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for $V_S = -5V$ to +600V.



DC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, @TA = +25°C, unless otherwise specified.) (Note 7)

Parameter	Parameter			Тур	Max	Unit	Conditions
Logic "1" (DGD2117) & Logic "0" (DGI Voltage (Note 8)	Vін	9.5	_	_	V	—	
Logic "0" (DGD2117) & Logic "1" (DGI Voltage (Note 8)	VIL	—		6.0	V	_	
High Level Output Voltage, VBIAS - VO		Vон	—	0.05	0.2	V	$I_0 = 2mA$
Low Level Output Voltage, Vo		Vol	—	0.02	0.1	V	$I_0 = 2mA$
Offset Supply Leakage Current		Ilk	—		50	μA	$V_B = V_S = 600V$
Quiescent VBS Supply Current		IBSQ	—	50	240	μA	VIN = 0V or Vcc
Quiescent Vcc Supply Current		lccq	—	70	340	μA	VIN = 0V or VCC
Logic "1" Input Bias Current	DGD2117 DGD2118	l _{IN+}	—	20	40	μA	$V_{IN} = V_{CC}$ $V_{IN} = 0V$
Logic "0" Input Bias Current	DGD2117 DGD2118	lin-	_	_	5.0	μA	$V_{IN} = 0V$ $V_{IN} = V_{CC}$
V _{BS} Supply Under-Voltage Positive Go	V _{BS} Supply Under-Voltage Positive Going Threshold			8.6	9.6	V	—
VBS Supply Under-Voltage Negative G	oing Threshold	VBSUV-	7.2	8.2	9.2	V	—
Vcc Supply Under-Voltage Positive G	Vccuv+	7.6	8.6	9.6	V	—	
Vcc Supply Under-Voltage Negative C	Vccuv-	7.2	8.2	9.2	V	—	
Output High Short Circuit Pulsed Curr	Io+	200	290	_	mA	$V_O = 0V$, $V_{IN} = Logic$ "1", PW $\leq 10 \mu s$	
Output Low Short Circuit Pulsed Curre	lo-	420	600	_	mA	Vo = 15V, VıN = Logic "0", PW ≤ 10µs	

Notes: 7. The V_{IN} and I_{IN} parameters are referenced to COM and are applicable to the logic input pins: IN and IN*. The V₀ and I₀ parameters are referenced to

COM and are applicable to the output pin: HO. 8. For optimal operation, it is recommended that the input pulses (IN and IN*) should have a minimum amplitude of 9.5V with a minimum pulse width of 250ns.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Мах	Unit	Conditions
Turn-On Propagation Delay	t _{ON}	—	125	200	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	toff	—	105	180	ns	Vs = 600V
Turn-On Rise Time	tr	—	75	130	ns	—
Turn-Off Fall Time	tf	—	35	65	ns	—



Timing Waveforms

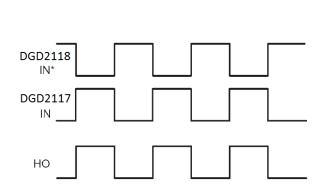


Figure 1. Input / Output Timing Diagram

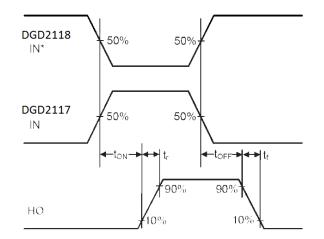


Figure 2. Switching Time Waveform Definitions



Typical Performance Characteristics (Vcc = 15V, @TA = +25°C, unless otherwise specified.)

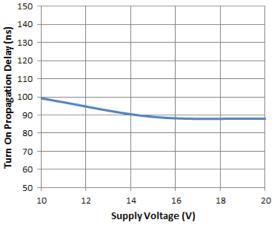


Figure 3. Turn-on Propagation Delay vs. Supply Voltage

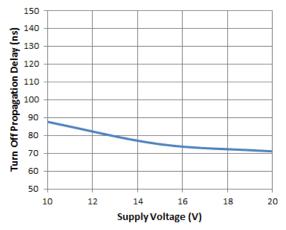
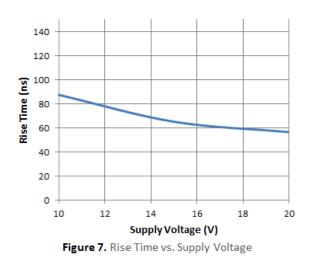


Figure 5. Turn-off Propagation Delay vs. Supply Voltage



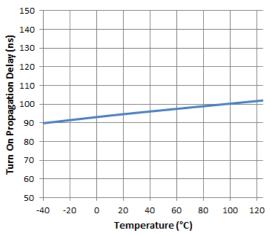


Figure 4. Turn-on Propagation Delay vs. Temperature

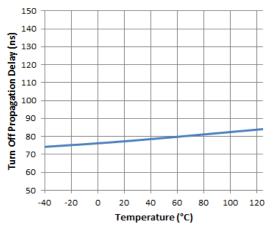


Figure 6. Turn-off Propagation Delay vs. Temperature

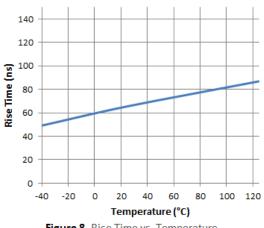


Figure 8. Rise Time vs. Temperature



Typical Performance Characteristics (continued)

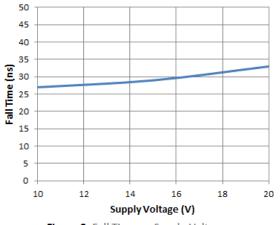


Figure 9. Fall Time vs. Supply Voltage

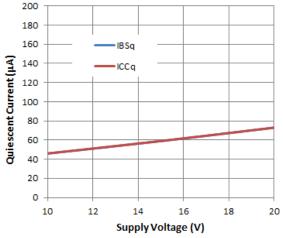


Figure 11. Quiescent Current vs. Supply Voltage

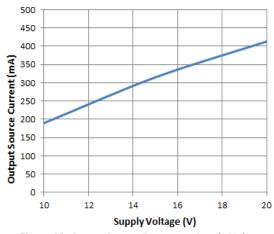
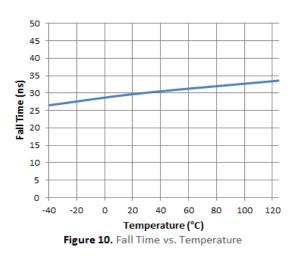
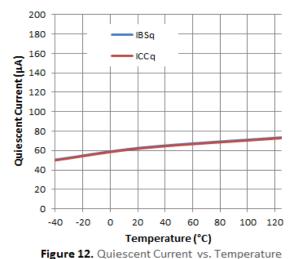


Figure 13. Output Source Current vs. Supply Voltage







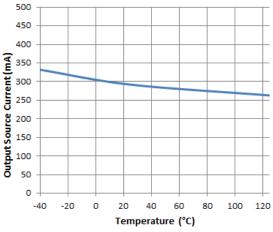
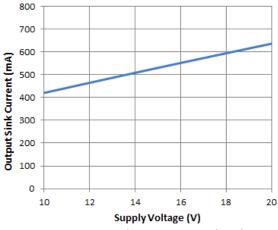


Figure 14. Output Source Current vs. Temperature



Typical Performance Characteristics (continued)





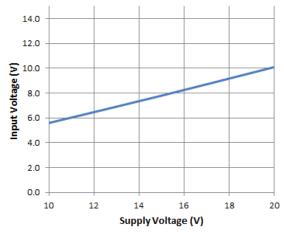
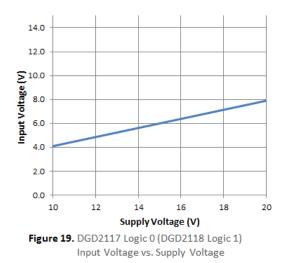
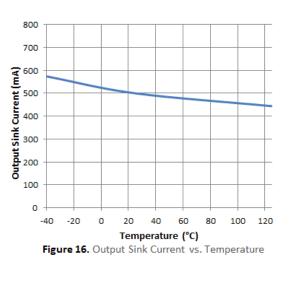


Figure 17. DGD2117 Logic 1 (DGD2118 Logic 0) Input Voltage vs. Supply Voltage





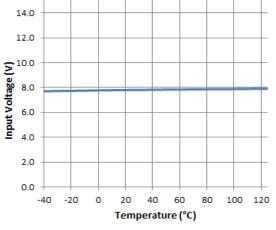
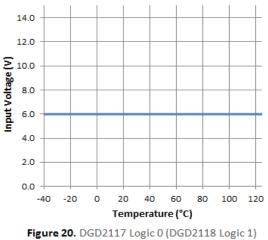


Figure 18. DGD2117 Logic 1 (DGD2118 Logic 0) Input Voltage vs. Temperature



Input Voltage vs. Temperature



Typical Performance Characteristics (continued)

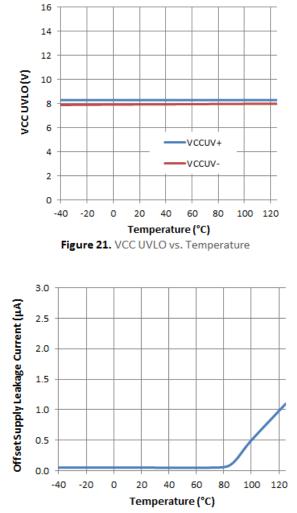
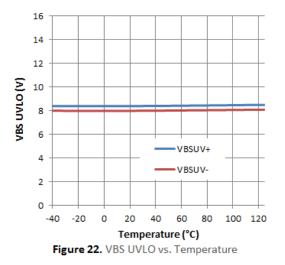


Figure 23. Offset Supply Leakage Current vs. Temperature





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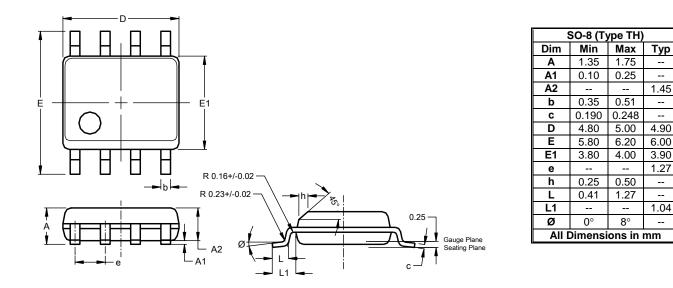
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Package Outline Dimensions

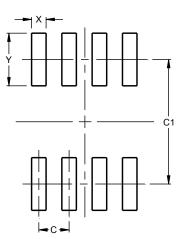
Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Type TH)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	1.27
C1	5.20
Х	0.60
Y	2.20

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking. Note:

SO-8 (Type TH)



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